

Technical Data Data Sheet N1189, Rev. B Green Products

203CNQ080/203CNQ100 SCHOTTKY RECTIFIER

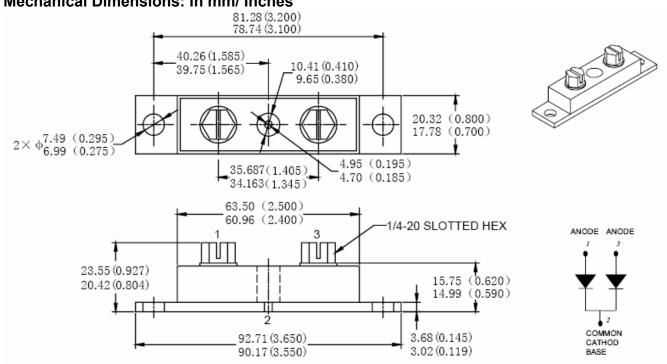
Applications:

- High current switching power supply Plating power supply Free-Wheeling diodes
- Reverse battery protection Converters UPS System Welding

Features:

- 175 °C T_J operation
- Center tap module
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Low forward voltage drop
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- · Additional testing can be offered upon request

Mechanical Dimensions: In mm/ Inches



PRM4 (Non-Isolated)

MARKING, MOLDING RESIN

Marking for 203CNQ080/100, 1st row SS YYWWL, 2nd row 203CNQ080/100 Where YY is the manufacture year WW is the manufacture week code L is the wafer's Lot Number Molding resin

Epoxy resin UL:94V-0

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Maximum Ratings:

Characteristics	Symbol	Condition	Max.		Units	
Peak Inverse Voltage	V_{RWM}	-	80 203CNQ080		V	
_			100	203CNQ100		
Max. Average Forward	I _{F(AV)}	50% duty cycle @T _C =110°C, rectangular wave form	100	per leg	Α	
			200	per device		
Max. Peak One Cycle Non- Repetitive Surge Current (per leg)	I _{FSM}	8.3 ms, half Sine pulse	2520		А	
Non-Repetitive Avalanche Energy(peg leg)	E _{AS}	T _J =25°C,I _{AS} =1A,L=30mH	15		mJ	
Repetitive Avalanche Current(peg leg)	I _{AR}	Current decaying linearly to zero in 1 µsec Frequency limited by T _J max. V _A =1.5× V _R typical	1		A	

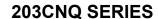
Electrical Characteristics:

Characteristics	Symbol	Condition	Max.	Units	
Max. Forward Voltage Drop (per leg) *	V_{F1}	@ 100A, Pulse, T _J = 25 °C	0.86	V	
		@ 200A, Pulse, T _J = 25 °C	1.03	V 	
	V_{F2}	@ 100A, Pulse, T _J = 125 °C	0.70	V	
		@ 200A, Pulse, T _J = 125 °C	0.84		
Max. Reverse Current (per	I_{R1}	$@V_R = rated V_R T_J = 25 °C$	3	mA	
leg) *	I _{R2}	$@V_R = \text{rated } V_R T_J = 125 ^{\circ}\text{C}$	40	mA	
Max. Junction Capacitance	C _T	$@V_R = 5V, T_C = 25 °C$	2650	Pf	
(per leg)		f _{SIG} = 1MHz	2000		
Typical Series Inductance	L _S	Measured lead to lead 5 mm	7.0	Nh	
(per leg)		from package body	1.0		
Max. Voltage Rate of Change	dv/dt	-	10,000	V/μs	
Insulation Volage	V_{RMS}	-	1000	V	

^{*} Pulse Width < 300µs, Duty Cycle <2%

Thermal-Mechanical Specifications:

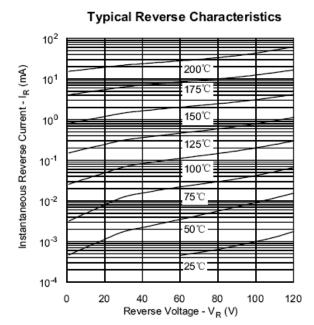
Characteristics	Symbol	Condition	Specifi	Units		
Max. Junction Temperature	T_J	-	-55 to	°C		
Max. Storage Temperature	T _{stg}	-	-55 to	°C		
Maximum Thermal Resistance Junction to Case (per leg)	$R_{ heta JC}$	DC operation	0.50		°C/W	
Maximum Thermal Resistance Junction to Case (per package)	$R_{ heta JC}$	DC operation	0.25		°C/W	
Typical Thermal Resistance, case to Heat Sink	$R_{ heta cs}$	Mounting surface, smooth and greased	0.10		°C/W	
Mounting Torque	Тм	-	Mounting Torque Terminal Torque	24(min) 35(max) 35(min) 46(max)	Kg-cm	
Approximate Weight	wt	-	79		g	
Case Style	PRM4 Isolated					

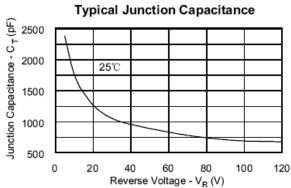




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Typical Forward Characteristics 10² 200°C 10¹ 175°C 10² 10² 25°C 10² 0.0 0.1 0.2 0.3 0.4 0.5 0.6 0.7 0.8 0.9 1.0 Forward Voltage Drop - V_F (V)





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